AN3130

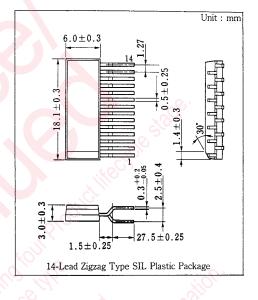
RF Converter Circuit

Outline

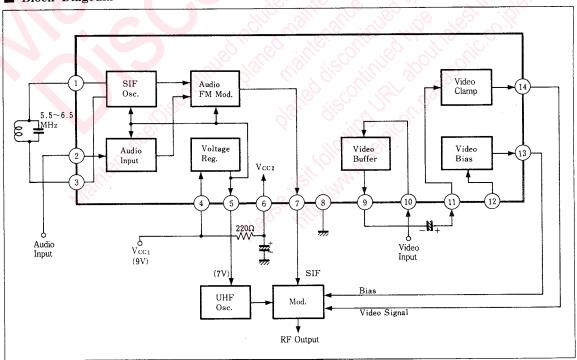
The AN3130 is an integrated circuit designed for an RF converter intended for a PAL region.

■ Features

- Incorporating a video buffer amp., sync. is not shortened.
- Voltage regulator.
- Variable video bias is supplied.



■ Block Diagram



Pin

Pin No.	Pin Name	Pin No.	Pin Name
1	SIF Osc. (1)	8	GND
2	Audio Input	9	Video Buffer Output
3	SIF Osc. (2)	10	Video Input
4	Vcc1	11	Video Clamp Input
5	Voltage Reg. Output	12	Video Bias Adj.
6	Vcc2	13	Video Bias Output
7	SIF Output	14	Video Output

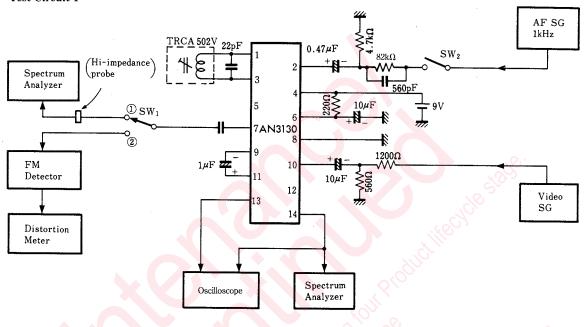
■ Absolute Maximum Ratings (Ta=25°C)

Item	Symbol	Rating	Unit
Supply voltage	V_{CC}	12	N A
Supply current	I _{cc}	50	mA
Power dissipation	P_{D}	600	mW
Operating ambient temperature	T_{opr}	$-20 \sim +70$	°C
Storage temperature	$T_{ m stg}$	$-55 \sim +150$	°C

■ Electrical Characteristics (Ta=25°C)

Item	Symbol	Test Circuit	Condition	min.	typ.	max.	Unit.
Supply current	Icc	1		12	16.5	21	mA
Stabilized power output	V_5	1	210 Mg. 11/6 11/1	6.5	7.0	7.5	V
Stabilized power stability	ΔV_5	1	Vcc=8~10V	-0.2	1/1/	+0.2	V
Video modulation degree	m	1	Pin① Open	77.5	82.5	87.5	%
Video output amplitude	$v_{\rm O}$	1	$Vin = 0.6V_{P-P}$	0.58	0.60	₹ 6°	V _{P-P}
Sync. distortion	Sync	1		-3.0		0	%
Sag	Sug	1	to the grant s	-4	2	+4	%
SIF frequency	f_S	1	, 60 60, 67	5.40	5.50	5.60	MHz
SIF output level	V _{SIF}	1	Pin⑦ Open	108	109	110	dΒμ
Sound FM modulation sensitivity	⊿f _{FM}	1	6. 2 11/2 10	±35	±50	±65	kHz
Sound FM modulation distortion	THD	1	101 01			1.0	%

Test Circuit 1



Measuring Conditions List

Item -	Input Condition		Marin Maria		sw	
	Video SG	AF SG	Measuring Method		2	
m	10-step wave 2V _{P-P}		$ \begin{array}{ccc} & & & \\ & & \\ & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & \\ & & & \\$	·6/		
Vo	10-step wave 2V _{P-P}	- 100	"JULCO Vo=b	2.5.		
Sync	$S/V = 3/7$ $2V_{P-P}$	-0,0	Sync. distortion = $\frac{1}{3}$ (7· $\frac{\text{Sync.}}{\text{Video}}$ -3) ×100			
Sug	Square wave 2V _{P-P}		$Sag = \frac{Sag}{Total \ amplitude} \times 100$	_	_	
fs	_	1/1/1 h.	Measure the output signal frequency of the Pin 7.	1	_	
$V_{\rm SIF}$	_		Measure a 5.5 MHz output level with a spectrum analyzer.	1	_	
Δf_{FM}	- (400Hz 0.5Vrms	Read a modulation degree.	2	ON	
THD		400Hz 0.5Vrms	Measure with a distortion gauge.	2	ON	

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